

VJ 6040 UHF Chip Antenna for Mobile Devices



The company's products are covered by one or more of the following:

WO2008250262 (A1), US2008303720 (A1),
US2008305750 (A1), WO2008154173 (A1).

Other patents pending.

DESCRIPTION

The VJ 6040 multi-layer ceramic chip antenna is a small form-factor, high-performance, chip-antenna designed for TV reception in mobile devices in the UHF band. It allows mobile TV device manufacturers to design high quality products that do not bear the penalty of a large external antenna. Utilizing Vishay's unique materials and manufacturing technologies, this product complies with the MBRAI standard while maintaining a small outline.

Focusing on consumer applications, the antenna is designed to be assembled onto a PC board in the standard reflow process.

Target customers of the VJ 6040 are mobile phone makers, portable multimedia device makers, notebook OEMs and ODMs, and accessory card OEMs and ODMs.

The VJ 6040 is the first of a family of products developed by Vishay, a world leader in manufacturing of discrete and passive components.

FEATURES

- Small outline (10.5 mm x 15.5 mm x 1.2 mm)
- Omni-directional, linear polarization
- Complies with MBRAI standard
- Complete UHF band coverage (470 MHz to 860 MHz) up to 1.1 GHz
- Requires a tuning circuit and ground plane for optimal performance
- Standard SMT assembly
- 50 Ω unbalanced interface
- Operating temperature range (- 40 °C to + 85 °C)
- Reference design and evaluation boards available upon request
- Compliant to RoHS directive 2002/95/EC

RoHS
COMPLIANT

APPLICATIONS

- Mobile UHF TV receivers including DVB-T, DVB-H, ISDB-T, CMMB, ATSC, and MediaFLO devices

ANTENNA PERFORMANCE

Peak gain

The antenna radiation characteristics are influenced by several factors including ground plane dimensions and impedance matching network.

The antenna parameters presented hereafter were measured according to the configuration suggested by the VJ 6040 evaluation board, utilizing its four channel active digital tuning circuit. The evaluation board ground plane is 40 mm by 80 mm large.

Figure 1 shows peak gain over frequency throughout the UHF band, compared with the MBRAI requirements.

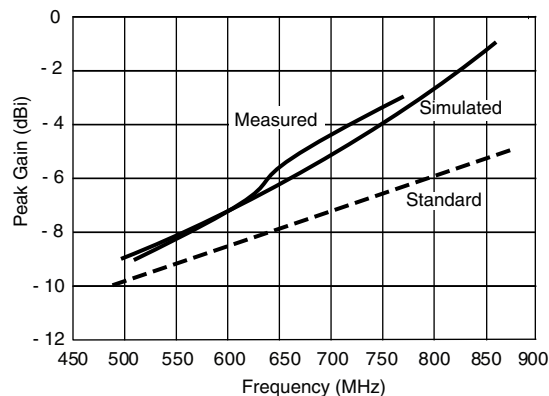


Fig. 1 - Peak gain vs. Frequency

Figure 2 displays the measured and simulated radiation efficiency of VJ 6040 over frequency.

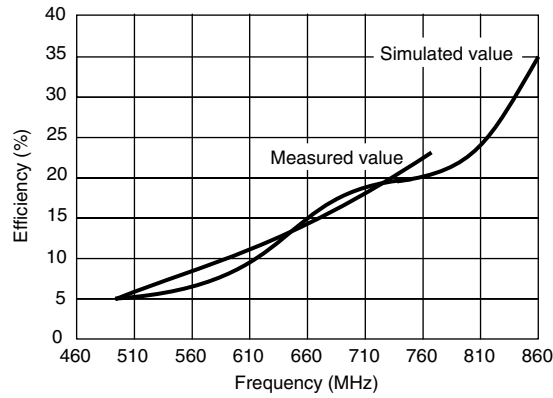


Fig. 2 - Radiation Efficiency vs. Frequency

Applications that do not require full coverage of the UHF band can gain an additional two to three dBi by removing the tuning circuit. In this case the antenna can be fixed to any 150 MHz band within the UHF range.

RADIATION PATTERN

The 3D planes of VJ 6040 are defined in figure 3.

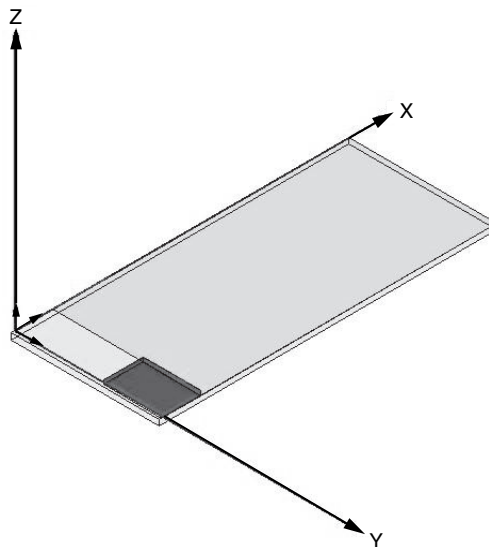


Fig. 3 - VJ 6040 3D Plane Definition

Figure 4. displays the simulated 3D radiation pattern at 650 MHz.

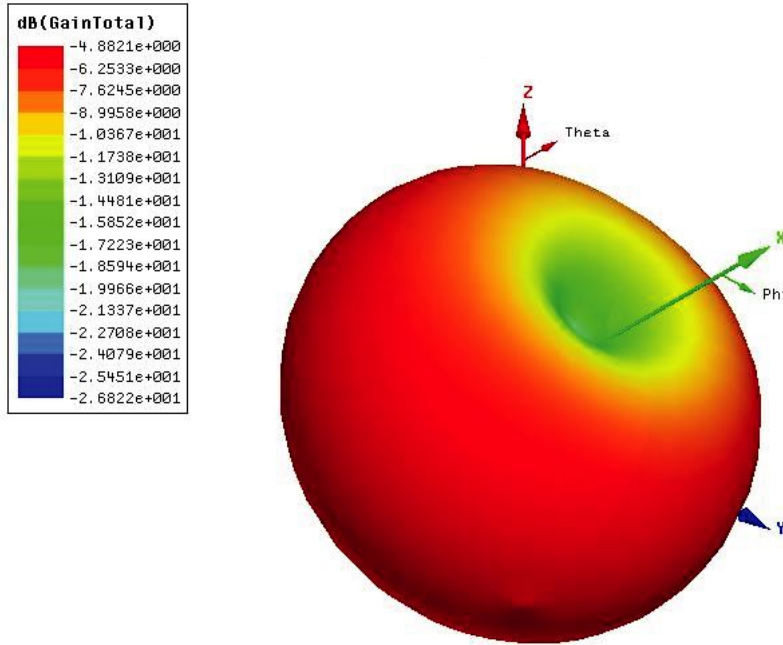


Fig. 4 - Simulated Radiation Pattern

Figure 5. displays the measured radiation patterns of VJ 6040 evaluation board in the YZ plane as defined in figure 3. Zero degrees is defined at the Z axis, stepping counter clockwise.

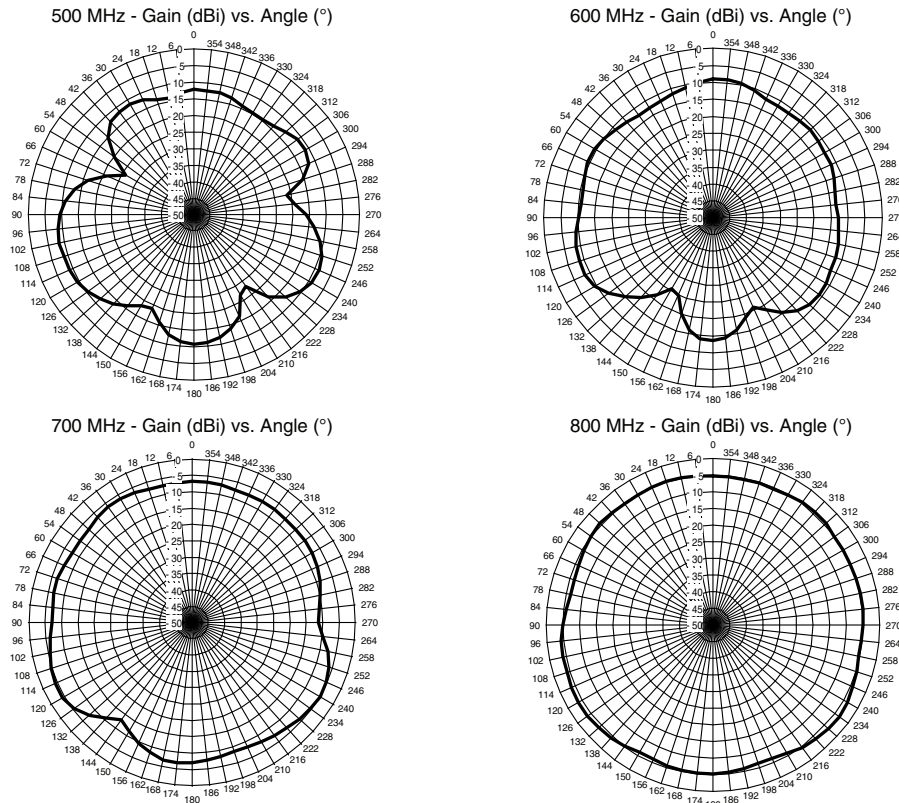


Fig. 5 - Measured Radiation Pattern

FOOTPRINT AND MECHANICAL DIMENSIONS

The antenna footprint and mechanical dimensions are presented in figure 6. For mechanical support, it is recommended to add one or two drops of heat curing epoxy glue. The glue dot should not overlap with any of the soldering pads. It is recommended to apply the glue dot at the center of the antenna, as shown by the diagonal pattern. For more details see “VJ 6040 Assembly Guidelines” section below.

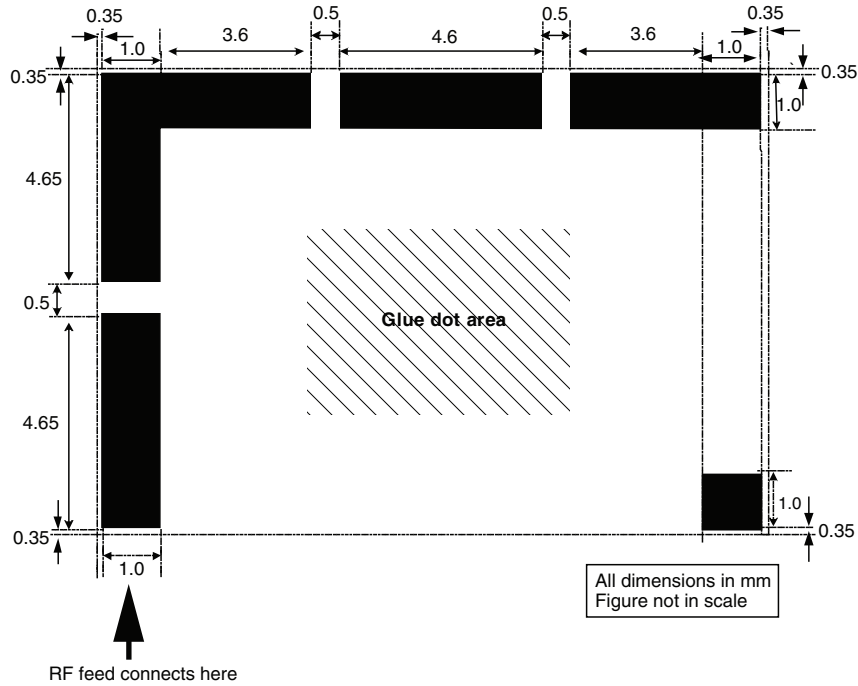


Fig. 6 - VJ 6040 Footprint

VJ 6040 ASSEMBLY GUIDELINES

1. Mounting of antennas on a printed circuit board should be done by reflow soldering. The reflow soldering profiles are shown below.
2. In order to provide the adequate strength between the antenna and the PCB the application of a dot of heat cured epoxy glue in the center of the footprint of the antenna prior to the antenna's soldering to the board should be done. An example for such glue could be Heraeus PD 860002 SA. The weight of the dot should be 5 mg to 10 mg.

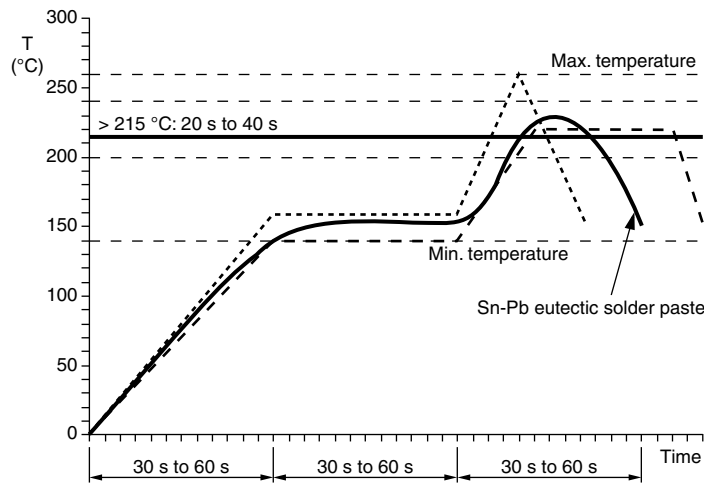


Fig. 7 - Soldering IR Reflow with SnPb Solder

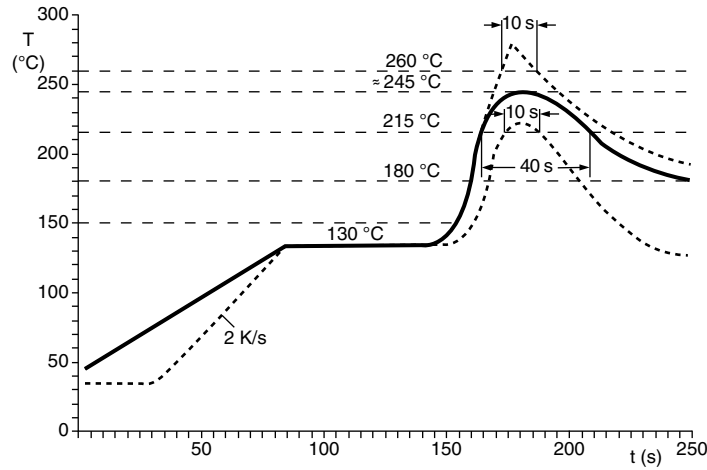


Fig. 8 - Soldering Reflow with Sn Solder

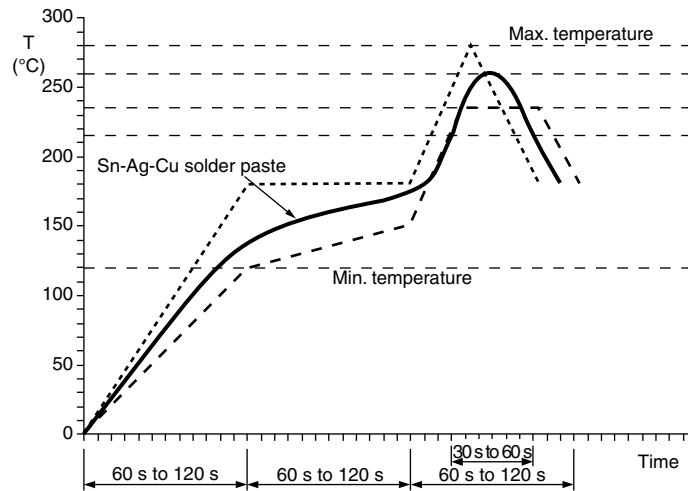


Fig. 9 - Soldering IR Reflow with SnAgCu Solder

ORDERING INFORMATION	VISHAY MATERIAL	PACKAGING QUANTITY
VJ 6040	VJ6040M011SXISRA0	1000 pieces



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